

## 1 Features and Benefits

- ☐ Wide operating voltage range: from 3.3V to 18V
- ☐ Less than 10 $\mu$ A average supply current in  $\mu$ -Power Mode
- ☐ Flexible magnetic thresholds and temperature coefficient
- ☐ Integrated self-diagnostic functions activating dedicated Safe Mode
- ☐ Reverse supply voltage protection
- ☐ Under-Voltage Reset protection
- ☐ Thermal protection
- ☐ Optional IMC integration for lateral sensing
- ☐ Customer end-of-line programming
- ☐ Wide programmable magnetic Latch/Switch range
- ☐ Developed according to ISO26262-10, 9 as safety HW element out of context with ASIL-B level

## 2 Application Examples

- ☐ Automotive, Consumer and Industrial
- ☐ Brake light wake-up switch
- ☐ Electronic Steering Column Lock
- ☐ Door latch system
- ☐ Seat positioning
- ☐ Sunroof/Tailgate opener
- ☐ Transmission applications
- ☐ Electrical power steering

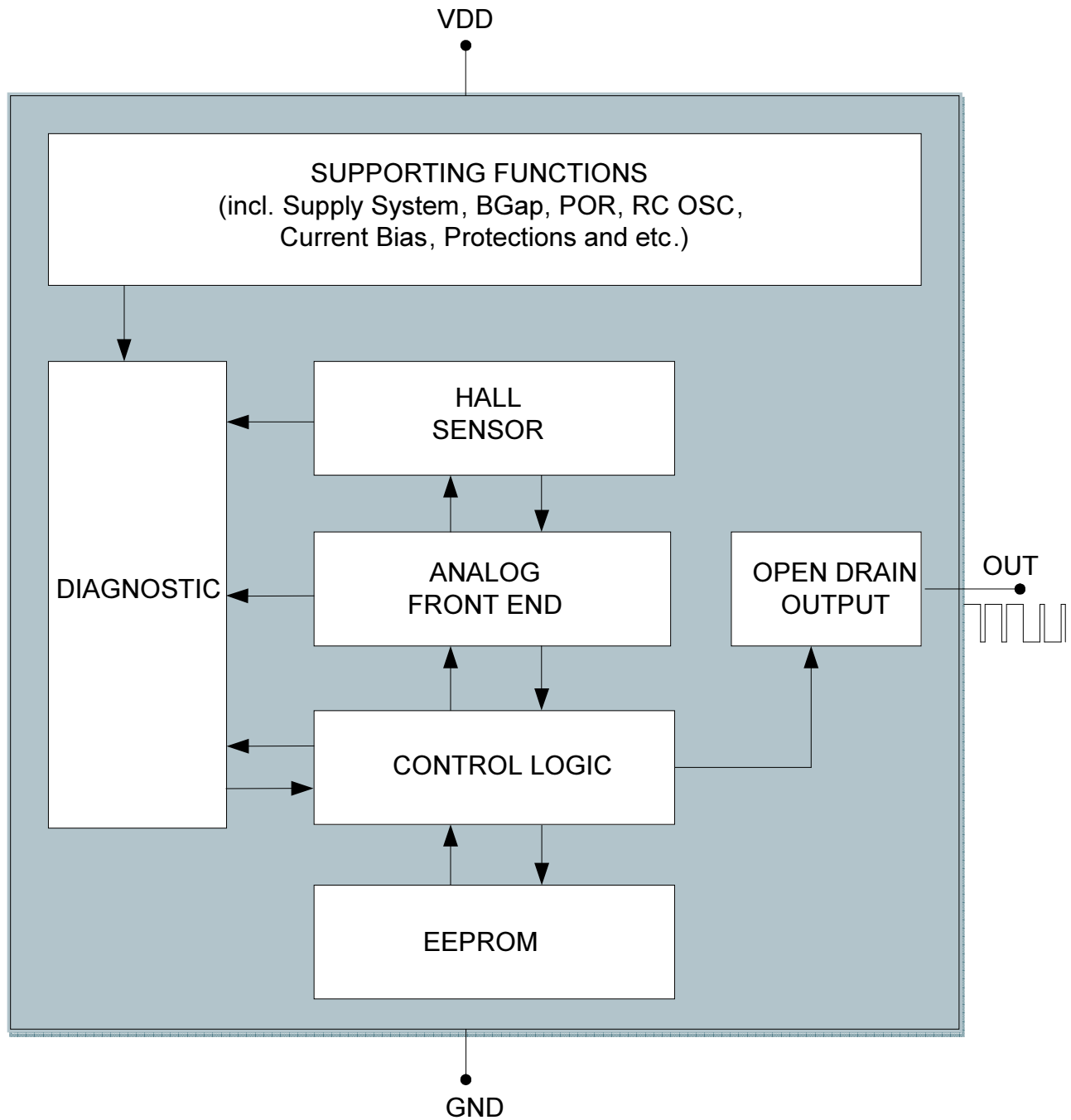
## 3 Ordering Information

Product Code	Temperature Code	Package Code	Option Code	Packing Form Code
MLX92292	L	SE	AAA-000	RE
MLX92292	L	UA	AAA-000	BU
MLX92292	L	SE	AAA-200	RE
MLX92292	L	SE	AAA-001	RE
MLX92291	L	SE	AAA-200	RE
MLX92291	L	SE	AAA-201	RE
MLX92291	L	SE	AAA-202	RE

**Legend:**

Temperature Code:	L (-40°C to 150°C)
Package Code:	SE = TSOT-23L UA = UA (TO92-3L)
Option Code:	000 => 3 wire hall effect Switch/Latch 200 => IMC version
Packing Form:	BU=Bulk   RE = Reel
Ordering example:	MLX92292LSE-AAA-001-RE

## 4 Functional Diagram



## 5 General Description

Melexis has made a major advance in magnetic sensing technology that will have widespread implications for modern automobile design the MLX92292 - effectively represents a whole new way of sensing. This device delivers switch functions, but unlike existing products on the market it can determine the presence of magnetic fields that are lateral, not just orthogonal, to it. The uniqueness of this offering is taken further by the fact that the MLX92292 switch is supporting an ASIL B safety integrity level (in accordance with ISO 26262), with an array of built-in diagnostic mechanisms available.

Flexibility is a key attribute of the MLX92292. OEM customers can chose straightforward pre-programmed units, or alternatively they can benefit from the end-of-line (EoL) programming capacity. Through this each device may be configured (via its output pin) during the OEM production process, so system optimization is fully realized. The programming facility also enables setting of both magnetic operating points to small increments across a range spanning -90mT to +90mT (-40mT to +40mT for lateral sensing versions).

The MLX92292 can be specified with standard orthogonal sensitivity or the lateral sensitivity option. The upshot of lateral sensitivity being that there is potential to replace multiple devices with a single surface mount unit, thereby saving valuable board space and lowering bill-of-materials costs. This stems directly from Melexis' proprietary Integrated Magnetic Concentrator (IMC™) technology, which enables substantial heightening of signal-to-noise ratios in magnetic field measurement. In addition, the capacity of this technology to sense laterally allows lower profile system implementations, as the magnet can move alongside the device rather than having to be above it.

Safeguarding the MLX92292 are reverse supply voltage, thermal, electro-static discharge (ESD) and over-voltage protections, plus Under-Voltage Reset features. With the capacity to deal with a 40V load dump, it can be connected directly to the vehicle battery. In order to achieve ASIL B compliance, numerous diagnostic/monitoring functions have been incorporated, including Hall sensor and analog frontend diagnostics. The device comprises a full set of programmable reporting features, giving it compatibility with any existing electronic control unit (ECU) interface. Only the normal application pins are required for this - without need of additional diagnostic pins and thus simplifying the design concept considerably.

# Table of Contents

<b>1</b>	<b>Features and Benefits</b>	<b>1</b>
<b>2</b>	<b>Application Examples</b>	<b>1</b>
<b>3</b>	<b>Ordering Information</b>	<b>1</b>
<b>4</b>	<b>Functional Diagram</b>	<b>2</b>
<b>5</b>	<b>General Description</b>	<b>3</b>
<b>6</b>	<b>Absolute Maximum Ratings</b>	<b>5</b>
<b>7</b>	<b>General Electrical Specifications</b>	<b>6</b>
<b>8</b>	<b>Version specific parameters</b>	<b>8</b>
8.1	MLX92292LSE-AAA-000-RE / MLX92292LUA-AAA-000-BU	8
8.2	MLX92292LSE-AAA-200-RE	9
8.3	MLX92292LSE-AAA-001-RE	9
8.4	MLX92291LSE-AAA-200-RE	10
8.5	MLX92291LSE-AAA-201-RE	10
8.6	MLX92291LSE-AAA-202-RE	10
<b>9</b>	<b>Magnetic Behaviour</b>	<b>12</b>
9.1	Latch Sensor	12
9.2	Unipolar Switch Sensor	13
<b>10</b>	<b>Functional Safety Capability</b>	<b>14</b>
10.1	Sensor Development	14
10.2	Technical Safety Requirements	14
10.2.1	TS_RQT_Mission	14
10.2.2	TS_RQT_Safe_Message	15
<b>11</b>	<b>Application Information</b>	<b>16</b>
11.1	Typical Automotive Application Circuit	16
11.2	Automotive and Harsh, Noisy Environments Application Circuit	16
<b>12</b>	<b>Package Information</b>	<b>17</b>
12.1	UA (TO92-3L) Package Information	17
12.2	SE (TSOT-3L) Package Information	18
<b>13</b>	<b>Standard information regarding manufacturability of Melexis products with different soldering processes</b>	<b>19</b>
<b>14</b>	<b>ESD Precautions</b>	<b>19</b>
<b>15</b>	<b>Contact</b>	<b>20</b>
<b>16</b>	<b>Disclaimer</b>	<b>20</b>

## 6 Absolute Maximum Ratings

Parameter	Symbol	Value	Units
Supply voltage <sup>(1, 2)</sup>	V <sub>DD</sub>	+28V	V
Supply voltage (Load Dump) <sup>(1, 4)</sup>	V <sub>DD</sub>	+ 45V	V
Supply current <sup>(1, 2, 3)</sup>	I <sub>DD</sub>	+20	mA
Supply current <sup>(1, 3, 4)</sup>	I <sub>DD</sub>	+50	mA
Reverse supply voltage <sup>(1, 2)</sup>	V <sub>DDREV</sub>	-24	V
Reverse supply voltage <sup>(1, 4)</sup>	V <sub>DDREV</sub>	-30	V
Reverse supply current <sup>(1, 2, 5)</sup>	I <sub>DDREV</sub>	-20	mA
Reverse supply current <sup>(1, 4, 5)</sup>	I <sub>DDREV</sub>	-40	mA
Output voltage <sup>(1, 2)</sup>	V <sub>OUT</sub>	+28	V
Output current <sup>(1, 2, 5)</sup>	I <sub>OUT</sub>	+20	mA
Reverse output voltage <sup>(1)</sup>	V <sub>OUTREV</sub>	-0.5	V
Reverse output current <sup>(1, 2)</sup>	I <sub>OUTREV</sub>	-50	mA
Maximum junction temperature <sup>(6)</sup>	T <sub>J</sub>	+165	°C
ESD sensitivity – HBM <sup>(7)</sup>	-	8	kV
ESD sensitivity – CDM <sup>(8)</sup>	-	1000	V

Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>1</sup> The maximum junction temperature should not be exceeded

<sup>2</sup> For maximum 1 hour

<sup>3</sup> Including current through protection device

<sup>4</sup> For maximum 500ms

<sup>5</sup> Through protection device

<sup>6</sup> For 1000 hours.

<sup>7</sup> Human Body Model according AEC-Q100-002 standard

<sup>8</sup> Charged Device Model according AEC-Q100-011 standard

## 7 General Electrical Specifications

DC Operating Parameters  $V_{DD} = 3.3V$  to  $18V$ ,  $T_A = -40^\circ C$  to  $150^\circ C$  (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ <sup>(1)</sup>	Max	Units
Under-Voltage Reset threshold	$V_{UVR}$	$V_{DD}$ monitoring during Active phase	1.8	2.5	3	V
UVR reaction time <sup>(2)</sup>	$t_{UVR}$	$V_{DD}$ monitoring during Active phase, $V_{DD} = V_{UVR} - 0.3V$	—	1	—	$\mu s$
Minimum supply voltage for defined output state <sup>(2)</sup>	$V_{DD1}$	$R_{PU} = 2.2k\Omega$ , $V_{PU} = 5V$	—	1	1.2	V
Output leakage <sup>(8)</sup>	$I_{OFF}$	$V_{OUT} = 18V$ , $T_A = -40..85^\circ C$	—	0.1	1	$\mu A$
Output leakage	$I_{OFF}$	$V_{OUT} = 18V$	—	—	5	$\mu A$
Output saturation voltage	$V_{OL}$	Fast Mode, $I_{OL} = 20mA$	0.1	0.25	0.7	V
Output saturation voltage	$V_{OL}$	$\mu$ -Power Mode, $I_{OL} = 10mA$	—	0.15	0.5	V
Output Rise Time <sup>(2,5)</sup> ( $R_{PU}$ dependent)	$t_R$	$R_{PU} = 2.2k\Omega$ , $V_{DD} = 12V$ , $V_{PU} = 5V$ $C_{LOAD} = 50pF$ to GND	0.3	0.6	1	$\mu s$
Output Fall Time <sup>(2,5)</sup> (On-chip controlled)	$t_F$	$R_{PU} = 2.2k\Omega$ , $V_{DD} = 12V$ , $V_{PU} = 5V$ $C_{LOAD} = 50pF$ to GND	0.3	0.6	1	$\mu s$
Power-On time <sup>(3, 4)</sup>	$t_{ON}$	$V_{DD} = 5V$ , $dV_{DD}/dt > 2V/\mu s$	—	0.5	1	ms
Power-On state	-	Output state during $t_{ON}$	High			—
Output update period	$T_{UPD}$	Fast Mode	—	40	45	$\mu s$
Programmable operating (output update) period	$T_{OP}$	$\mu$ -Power Mode, typical range	0.16 <sup>(1)</sup>	—	260 <sup>(1)</sup>	ms
Operating period 1 (1 <sup>st</sup> ref. value)	$T_{OP1}$	$\mu$ -Power Mode	196	222	246	ms
Operating period 2 (2 <sup>nd</sup> ref. value)	$T_{OP2}$	$\mu$ -Power Mode	40	45	50	ms
Programmable diagnostic period in Fail Safe state	$T_{DP}$	Fast Mode, typical range	0.13 <sup>(1)</sup>	—	260 <sup>(1)</sup>	ms
Programmable "Output Ticking" repetition period	$T_{TICK}$	Equal to (multiple of) $T_{OP}$ , typical range	0.6 <sup>(1)</sup>	—	260 <sup>(1)</sup>	ms
Programmable "Output Ticking" duration	$t_{TICK}$	Typical range	4	—	128	$\mu s$
Active phase duration, diagnostic On	$t_{ACT\_Don}$	$\mu$ -Power Mode, defined at $I_{DD} > 0.7mA$	—	40	—	$\mu s$
Active phase duration, diagnostic Off	$t_{ACT\_Doff}$	$\mu$ -Power Mode, defined at $I_{DD} > 0.7mA$	—	24	—	$\mu s$
Tolerance of operating period ratio $t_{ACT}/T_{OP}$	$R_{TOL}$	$\mu$ -Power Mode	-5	0	5	%
Active phase supply current, diagnostic On (average value)	$I_{DDACT\_Don}$	$\mu$ -Power Mode	1.8	2.4	2.9	mA
Active phase supply current, diagnostic Off (average value)	$I_{DDACT\_Doff}$	$\mu$ -Power Mode	2.2	3	3.5	mA
Standby phase supply current <sup>(8)</sup>	$I_{DDSTBY}$	$V_{DD} \leq 16V$ , $T_A = -40..85^\circ C$	—	6	9	$\mu A$
Standby phase supply current	$I_{DDSTBY}$	$V_{DD} \leq 16V$	—	6	27	$\mu A$
Average supply current <sup>(8,9)</sup>	$I_{DDAVG1}$	$V_{DD} \leq 16V$ , $T_A = -40..85^\circ C$ , $T_{OP} = T_{OP1}$	—	6.4	9.5	$\mu A$
Average supply current <sup>(8,9)</sup>	$I_{DDAVG2}$	$V_{DD} \leq 16V$ , $T_A = -40..85^\circ C$ , $T_{OP} = T_{OP2}$	—	8.1	11.7	$\mu A$
Step response time <sup>(2)</sup>	$t_{RESP}$	Fast Mode, $B_{OP} = 1mT$ , $B_{RP} = -1mT$ , square wave magnetic field with $B > \pm 4mT$ , $t_{RISE} = t_{FALL} \leq 5\mu s$	15	40	65	$\mu s$
Signal bandwidth <sup>(2,6)</sup>	BW	Fast Mode, $B_{OP} = 1mT$ , $B_{RP} = -1mT$ , sine wave magnetic field with amplitude 5mT	6	8	—	kHz
Peak supply current <sup>(2)</sup>	$I_{DDPEAK}$	For peak duration $\geq 5\mu s$	—	2.9	3.6	mA
Fast Mode supply current	$I_{DDFAST}$		2.2	2.9	3.5	mA
Fast Mode fail supply current	$I_{DDFAIL}$		0.1	0.3	0.6	mA

Reverse supply current	$I_{DDREV}$	$V_{DD} = -16V$	-1	—	—	mA
Thermal Protection Activation	$T_{PROT}$		—	185 <sup>(7)</sup>	—	°C
Thermal Protection Release	$T_{REL}$		—	175 <sup>(7)</sup>	—	°C
UA package thermal resistance	$R_{THJA}$	Single layer PCB, JEDEC standard test boards, still air (LFPM=0)	—	200	—	°C/W
SE package thermal resistance	$R_{THJA}$	Single layer PCB, JEDEC standard test boards, still air (LFPM=0)	—	300	—	°C/W

1 Unless otherwise specified the typical values are defined at  $T_A = +25^\circ\text{C}$  and  $V_{DD} = 12V$

2 Guaranteed by design and verified by characterization, not production tested

3 The Power-On Time represents the time from reaching  $V_{DD} = 3.3V$  to the first refresh of the output state.

4 Power-On Slew Rate is not critical for the proper device start-up.

5  $R_{PU}$  and  $V_{PU}$  are respectively the external pull-up resistor and pull-up power supply

6 OUT switching should track magnetic field frequency without missing pulses

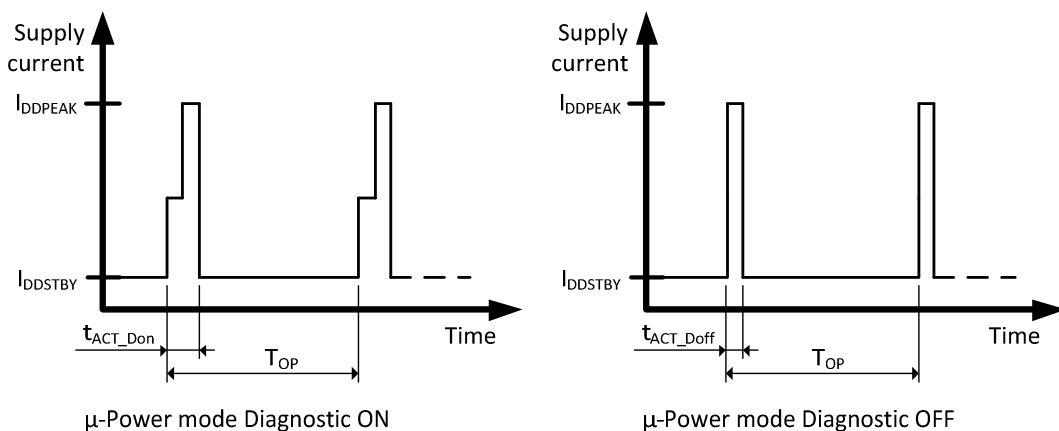
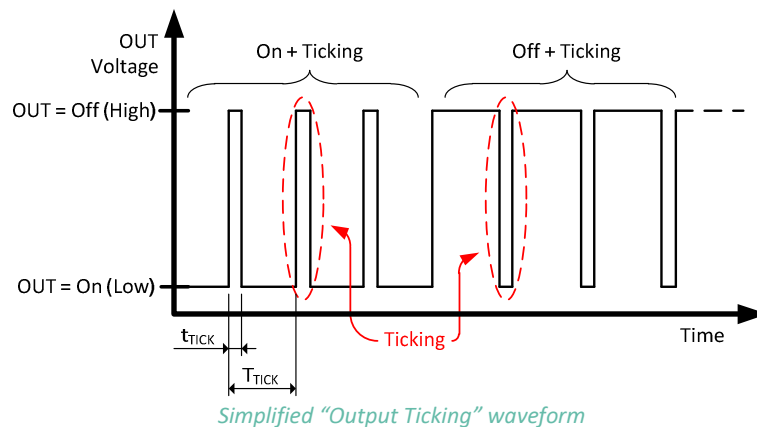
7  $T_{PROT}$  and  $T_{REL}$  are the corresponding junction temperature values

8 Guaranteed by correlation with production test at  $T_A = 150^\circ\text{C}$  and verified by characterization

9 Average current consumption for  $\mu$ -Power Mode with diagnostic On

$$I_{DDAVG} = \frac{I_{DDACT} * t_{ACT} * (1 + R_{TOL}/100) + I_{DDSTBY} * (T_{OP} - t_{ACT} * (1 + R_{TOL}/100))}{T_{OP}}$$

where  $t_{ACT}$  and  $T_{OP}$  are always typical values. The maximum  $I_{DDACT}$ ,  $I_{DDSTBY}$  and  $R_{TOL}$  spec values should be used for the maximum  $I_{DDAVG}$  calculation.



Simplified supply current waveform in  $\mu$ -Power mode

## 8 Version specific parameters

### 8.1 MLX92292LSE-AAA-000-RE / MLX92292LUA-AAA-000-BU

DC Operating Parameters  $V_{DD} = 3.3V$  to  $18V$ ,  $T_A = -40^{\circ}C$  to  $150^{\circ}C$  (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ <sup>(4)</sup>	Max	
Operating Point programming range <sup>(4)</sup>	B <sub>OP</sub>	$V_{DD} = 12V$ , $T_A = 25^{\circ}C$	-90	—	90	mT
Release Point programming range <sup>(4)</sup>	B <sub>RP</sub>	$V_{DD} = 12V$ , $T_A = 25^{\circ}C$	-90	—	90	mT
Operating Point magnitude programming <sup>(5, 6)</sup>	B <sub>OP</sub>		—	12	—	bit
Release Point magnitude programming <sup>(5, 6)</sup>	B <sub>RP</sub>		—	12	—	bit
Operating Point polarity selection	B <sub>OP</sub>		—	1	—	bit
Release Point polarity selection	B <sub>RP</sub>		—	1	—	bit
Direct or inverted output selection	—		—	1	—	bit
Factory pre-programmed Operating Point, Latch	B <sub>OP</sub>	$V_{DD} = 12V$ , $T_A = 25^{\circ}C$ , programming target 25mT	22	25	28	mT
Factory pre-programmed Release Point, Latch	B <sub>RP</sub>	$V_{DD} = 12V$ , $T_A = 25^{\circ}C$ , programming target -25mT	-28	-25	-22	mT
Temperature Coefficient programming range <sup>(3, 8)</sup>	TC	$V_{DD} = 12V$ , Latch with B <sub>OP</sub> = 25mT, B <sub>RP</sub> = -25mT	-2400 <sup>(7)</sup>		0 <sup>(7)</sup>	ppm/ $^{\circ}C$
Temperature Coefficient selection	TC		—	5	—	bit

IMC	Safe message	Operating period, ms	Diagnostic period in Fail Safe state, ms	“Output Ticking” duration, $\mu s$	“Output Ticking” repetition period, ms
No	TickMsg	45	-	128	45



## MLX92292

3-wire  $\mu$ Power programmable ASIL B capable Hall Effect Latch/Switch

Datasheet

### 8.2 MLX92292LSE-AAA-200-RE

DC Operating Parameters  $V_{DD} = 3.3V$  to  $18V$ ,  $T_A = -40^\circ C$  to  $150^\circ C$  (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ <sup>(9)</sup>	Max	
Operating Point programming range <sup>(9)</sup>	B <sub>OP</sub>	$V_{DD} = 12V$ , $T_A = 25^\circ C$	-40	—	40	mT
Release Point programming range <sup>(9)</sup>	B <sub>RP</sub>	$V_{DD} = 12V$ , $T_A = 25^\circ C$	-40	—	40	mT
Operating Point magnitude programming <sup>(5, 6)</sup>	B <sub>OP</sub>		—	12	—	bit
Release Point magnitude programming <sup>(5, 6)</sup>	B <sub>RP</sub>		—	12	—	bit
Operating Point polarity selection	B <sub>OP</sub>		—	1	—	bit
Release Point polarity selection	B <sub>RP</sub>		—	1	—	bit
Direct or inverted output selection	—		—	1	—	bit
Factory pre-programmed Operating Point, Latch	B <sub>OP</sub>	$V_{DD} = 12V$ , $T_A = 25^\circ C$ , programming target 20mT	17	20	23	mT
Factory pre-programmed Release Point, Latch	B <sub>RP</sub>	$V_{DD} = 12V$ , $T_A = 25^\circ C$ , programming target -20mT	-23	-20	-17	mT
Temperature Coefficient programming range <sup>(3, 8)</sup>	TC	$V_{DD} = 12V$ , Latch with B <sub>OP</sub> = 20mT, B <sub>RP</sub> = -20mT	-2400 <sup>(7)</sup>		0 <sup>(7)</sup>	ppm/ $^\circ C$
Temperature Coefficient selection	TC		—	5	—	bit

IMC	Safe message	Operating period, ms	Diagnostic period in Fail Safe state, ms	“Output Ticking” duration, $\mu s$	“Output Ticking” repetition period, ms
Yes	TickMsg	45	-	128	45

### 8.3 MLX92292LSE-AAA-001-RE

DC Operating Parameters  $V_{DD} = 3.3$  to  $18V$ ,  $T_A = -40^\circ C$  to  $150^\circ C$

Test Condition	Operating Point B <sub>OP</sub> (mT)			Release Point B <sub>RP</sub> (mT)			TC (ppm/ $^\circ C$ )	Output behaviour	Active Pole
	Min	Typ <sup>(2)</sup>	Max	Min	Typ <sup>(2)</sup>	Max	Typ <sup>(2)</sup>		
$T_A = -40^\circ C$	8.7	11	13.5	7.2	9.3	11.7	-1100 <sup>(3)</sup>	Inverted switch	South pole
$T_A = 25^\circ C$	8.6	10	11.4	7.2	8.5	9.8			
$T_A = 150^\circ C$	6.7	8.6	10.7	5.6	7.4	9.4			

IMC	Safe message	Operating period, ms	Diagnostic period in Fail Safe state, ms	“Output Ticking” duration, $\mu s$	“Output Ticking” repetition period, ms
No	uNoDiag	0.16	-	-	-

## MLX92292

3-wire  $\mu$ Power programmable ASIL B capable Hall Effect Latch/Switch

### Datasheet

## 8.4 MLX92291LSE-AAA-200-RE

DC Operating Parameters  $V_{DD} = 3.3$  to 18V,  $T_A = -40^\circ\text{C}$  to  $150^\circ\text{C}$

Test Condition	Operating Point $B_{OP}$ (mT)			Release Point $B_{RP}$ (mT)			TC (ppm/ $^\circ\text{C}$ )	Output behaviour	Active Pole
	Min	Typ <sup>(2)</sup>	Max	Min	Typ <sup>(2)</sup>	Max	Typ <sup>(2)</sup>		
$T_A = -40^\circ\text{C}$	7.6	10.5	13.6	5.6	8.1	11	-2200 <sup>(3)</sup>	Inverted switch	South pole
$T_A = 25^\circ\text{C}$	7	9	11	5.1	7	8.9			
$T_A = 150^\circ\text{C}$	4.5	6.6	8.9	3.2	5.2	7.2			

IMC	Safe message	Operating period, ms	Diagnostic period in Fail Safe state, ms	"Output Ticking" duration, $\mu\text{s}$	"Output Ticking" repetition period, ms
Yes	FlddMsg	-	2	-	-

## 8.5 MLX92291LSE-AAA-201-RE

DC Operating Parameters  $V_{DD} = 3.3$  to 18V,  $T_A = -40^\circ\text{C}$  to  $150^\circ\text{C}$

Test Condition	Operating Point $B_{OP}$ (mT)			Release Point $B_{RP}$ (mT)			TC (ppm/ $^\circ\text{C}$ )	Output behaviour	Active Pole
	Min	Typ <sup>(2, 6)</sup>	Max	Min	Typ <sup>(2, 6)</sup>	Max	Typ <sup>(2)</sup>		
$T_A = -40^\circ\text{C}$	7.0	9.6	12.5	6.7	9.3	12.1	-1100 <sup>(3)</sup>	Inverted switch	South pole
$T_A = 25^\circ\text{C}$	7.0	8.8	10.7	6.7	8.5	10.4			
$T_A = 150^\circ\text{C}$	5.4	7.7	10.2	5.2	7.4	9.9			

IMC	Safe message	Operating period, ms	Diagnostic period in Fail Safe state, ms	"Output Ticking" duration, $\mu\text{s}$	"Output Ticking" repetition period, ms
Yes	uNoDiag	45	-	-	-

## 8.6 MLX92291LSE-AAA-202-RE

DC Operating Parameters  $V_{DD} = 3.3$  to 18V,  $T_A = -40^\circ\text{C}$  to  $150^\circ\text{C}$

Test Condition	Operating Point $B_{OP}$ (mT)			Release Point $B_{RP}$ (mT)			TC (ppm/ $^\circ\text{C}$ )	Output behaviour	Active Pole
	Min	Typ <sup>(2)</sup>	Max	Min	Typ <sup>(2)</sup>	Max	Typ <sup>(2)</sup>		
$T_A = -40^\circ\text{C}$	3.8	5.9	8.2	2.8	4.8	7.0	-1100 <sup>(3)</sup>	Inverted switch	South pole
$T_A = 25^\circ\text{C}$	3.8	5.4	7.0	2.9	4.4	6.0			
$T_A = 150^\circ\text{C}$	2.8	4.7	6.8	2.0	3.9	5.8			

IMC	Safe message	Operating period, ms	Diagnostic period in Fail Safe state, ms	"Output Ticking" duration, $\mu\text{s}$	"Output Ticking" repetition period, ms
Yes	uNoDiag	10	-	-	-

1 Melexis production testing is limited to version specific parameters only

2 Unless otherwise specified the typical values are defined at  $T_A = +25^\circ\text{C}$  and  $V_{DD} = 12\text{V}$

3 The Temperature Coefficient is calculated using following formula:

$$TC = \frac{B_{XPTA2} - B_{XPTA1}}{B_{XPTA1} * (T_{A2} - T_{A1})} * 10^6, \text{ppm}/^\circ\text{C}$$

where:

$T_{A1} = 25^\circ\text{C}$ ,  $T_{A2} = 150^\circ\text{C}$ ,

# 390109229202

Rev.005

# MLX92292

## 3-wire $\mu$ Power programmable ASIL B capable Hall Effect Latch/Switch

### Datasheet

In case of magnetic Latch application:  $B_{XPTA1} (B_{XPTA2}) = B_{OP} - B_{RP}$  at  $T_{A1} (T_{A2})$

In case of magnetic Switch application:  $B_{XPTA1} (B_{XPTA2}) = B_{OP}$  or  $B_{RP}$  at  $T_{A1} (T_{A2})$

4 Guaranteed by correlation with production test at  $B=25mT$  and verified by characterization

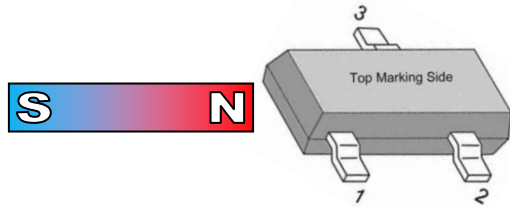
5 The programming step is  $<0.5\%$  of the programmed  $B_{OP}$  or  $B_{RP}$  value for  $|B_{OP}|$  or  $|B_{RP}| \geq 6mT$  and  $<0.02mT$  for  $|B_{OP}|$  or  $|B_{RP}| \leq 6mT$  at  $T_A = +25^\circ C$

6 Very low hysteresis magnitude ( $B_{OP} - B_{RP} < 1mT$ ) could lead to output toggling due to noise and mechanical looseness in the magnetic system.

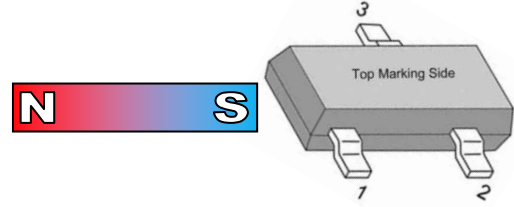
7 TC target values

8 The factory pre-programmed target TC value is  $0ppm/^\circ C$ .

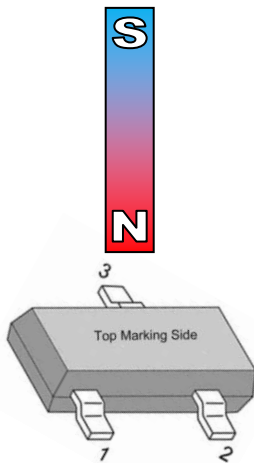
9 Guaranteed by correlation with production test at  $B=20mT$  and verified by characterization



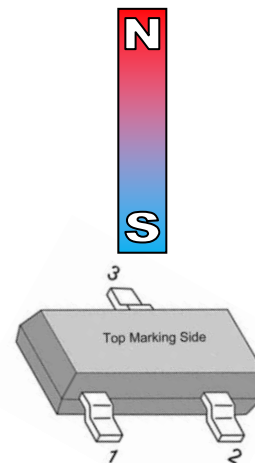
North active pole (IMC version)



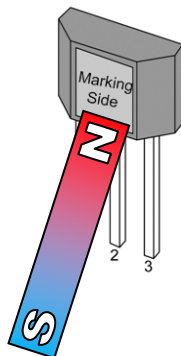
South active pole (IMC version)



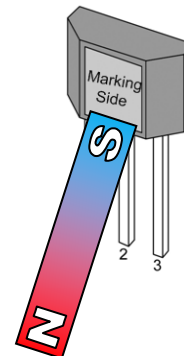
North active pole



South active pole



North active pole



South active pole

## 9 Magnetic Behaviour

### 9.1 Latch Sensor

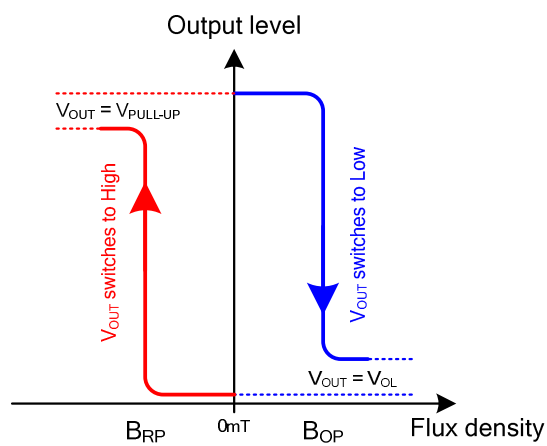


Fig.1 – South Pole Active

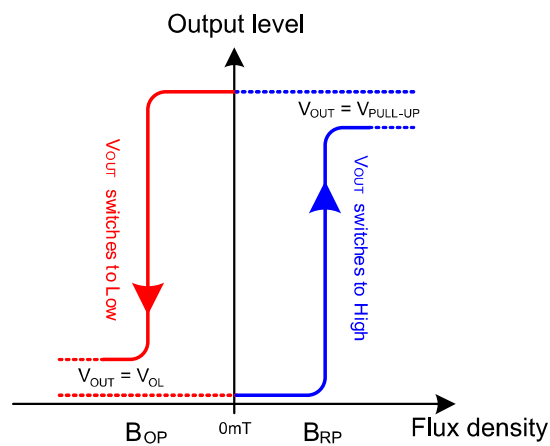


Fig.2 – North Pole Active

## 9.2 Unipolar Switch Sensor

Magnetic Field	Output Polarity	Remark
South	Direct South Switch	Fig.3
South	Inverted South Switch	Fig.4
North	Direct North Switch	Fig.5
North	Inverted North Switch	Fig.6

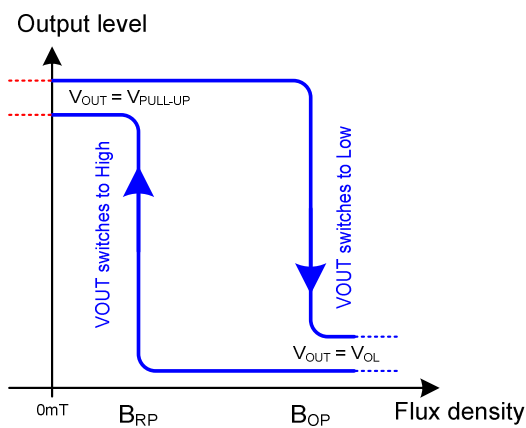


Fig.3 – Direct South Switch

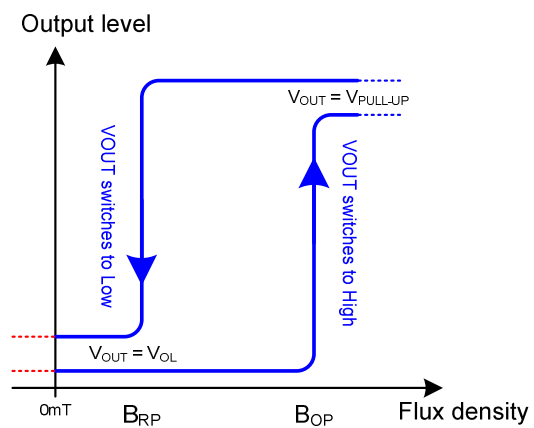


Fig.4 – Inverted South Switch

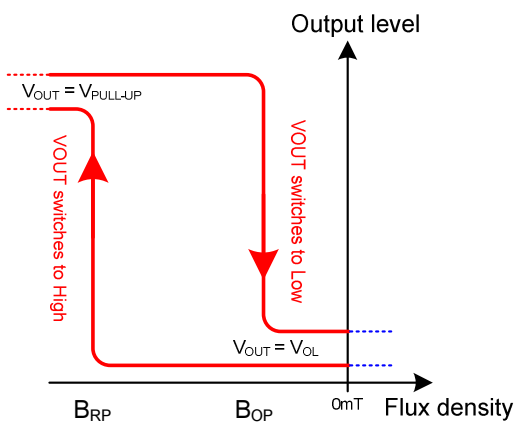


Fig.5 – Direct North Switch

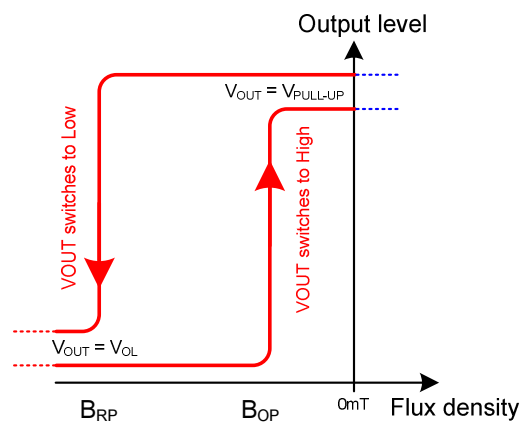


Fig.6 – Inverted North Switch

## 10 Functional Safety Capability

### 10.1 Sensor Development

MLX92292 is developed according to the ISO26262 requirements for ASIL B level.

### 10.2 Technical Safety Requirements

The main (mission) technical safety requirement for MLX92292 is the following:

#### 10.2.1 TS\_RQT\_Mission

ASIL: B

MLX92292 shall not provide wrong information about the detection of presence of magnetic field done by comparing the magnetic field with magnetic thresholds Bop and Brp, each of them being within a Safe Tolerance Interval (STI) defined in mT as  $\pm a \cdot B_{xp} \pm b$ , where Bxp is the actual magnetic threshold (Bop or Brp) and a, b are parameters depending on sensitivity direction and application temperature range. The following table shows the values of a and b for normal and lateral sensitivity device (with IMC) at 25°C and over the full temperature range.

	Ta = 25°C	Ta = -40°C..150°C
<b>Normal (orthogonal) sensitive device</b>	a = 0.18 (18%)	a = 0.22 (22%)
	b = 1.4mT	b = 1.7mT
<b>Lateral sensitive device (with IMC)</b>	a = 0.18 (18%)	a = 0.22 (22%)
	b = 2mT	b = 2.4mT

### 10.2.2 TS\_RQT\_Safe\_Message

MLX92292 shall report detected failures that could prevent TS\_RQT\_Mission.

One of the following programmable Safe Message options can be chosen depending on the application:

Message Option	B<Brp Diagnostic OK	B>Bop Diagnostic OK	All B values Diagnostic Failed	Diagnostic Coverage	Safe States
<b><math>\mu</math>-Power Mode</b>				<b>SPFM</b>	
TickMsg <sup>(1,2)</sup>	OUT = Off+Ticking	OUT = On+Ticking	OUT = Off	92%	B <sub>OP</sub> , B <sub>RP</sub> within STI ; OUT = On/Off w/o ticking
TickOffMsg <sup>(1)</sup>	OUT = Off+Ticking	OUT = On	OUT = Off	82%	B <sub>OP</sub> , B <sub>RP</sub> within STI ; OUT = Off
TickOnMsg <sup>(2)</sup>	OUT = Off	OUT = On+Ticking	OUT = On	55%	B <sub>OP</sub> , B <sub>RP</sub> within STI ; OUT = On
OutOffMsg	OUT = Off	OUT = On	OUT = Off	82%	B <sub>OP</sub> , B <sub>RP</sub> within STI ; OUT = Off
OutOnMsg	OUT = Off	OUT = On	OUT = On	55%	B <sub>OP</sub> , B <sub>RP</sub> within STI ; OUT = On
StbyX2Msg <sup>(3)</sup>	OUT = Off	OUT = On	OUT = Off Twice increased T <sub>OP</sub>	77%	B <sub>OP</sub> , B <sub>RP</sub> within STI ; Twice increased Top
uNoDiag <sup>(4)</sup>	OUT = Off	OUT = On	-	No diagnostic	B <sub>OP</sub> , B <sub>RP</sub> within STI
<b>Fast Mode</b>					
FIdMsg	OUT = Off, I <sub>DD</sub> = I <sub>DDFAST</sub>	OUT = On, I <sub>DD</sub> = I <sub>DDFAST</sub>	OUT = Off, I <sub>DD</sub> = I <sub>DDFAIL</sub>	67%	B <sub>OP</sub> , B <sub>RP</sub> within STI ; OUT=Off & I <sub>DD</sub> =I <sub>DDFAIL</sub>
FNoDiag <sup>(4)</sup>	OUT = Off	OUT = On	-	No diagnostic	B <sub>OP</sub> , B <sub>RP</sub> within STI

Note (1) Off+Ticking signal means that the Off state duration lasts significantly longer than the On state duration.

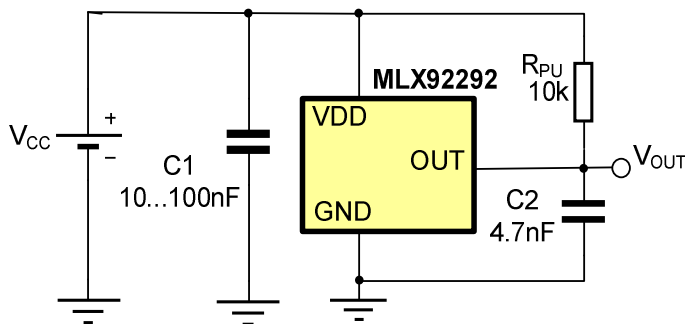
Note (2) On+Ticking signal means that the On state duration lasts significantly longer than the Off state duration.

Note (3) If T<sub>OP</sub> is set <5ms then T<sub>OP</sub> increases less than twice in case of diagnostic fail.

Note (4) This message option does not offer integrated diagnostic.

## 11 Application Information

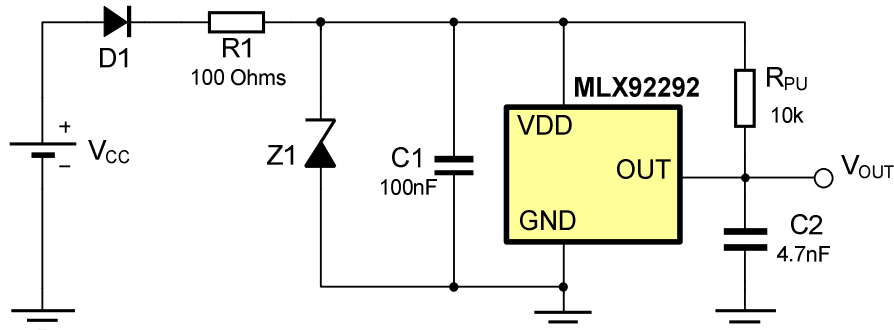
### 11.1 Typical Automotive Application Circuit



**Notes:**

1. For proper operation, a 10nF to 100nF bypass capacitor should be placed as close as possible to the  $V_{DD}$  and ground pin.
2. A capacitor connected to the output will improve the EMC performance

### 11.2 Automotive and Harsh, Noisy Environments Application Circuit



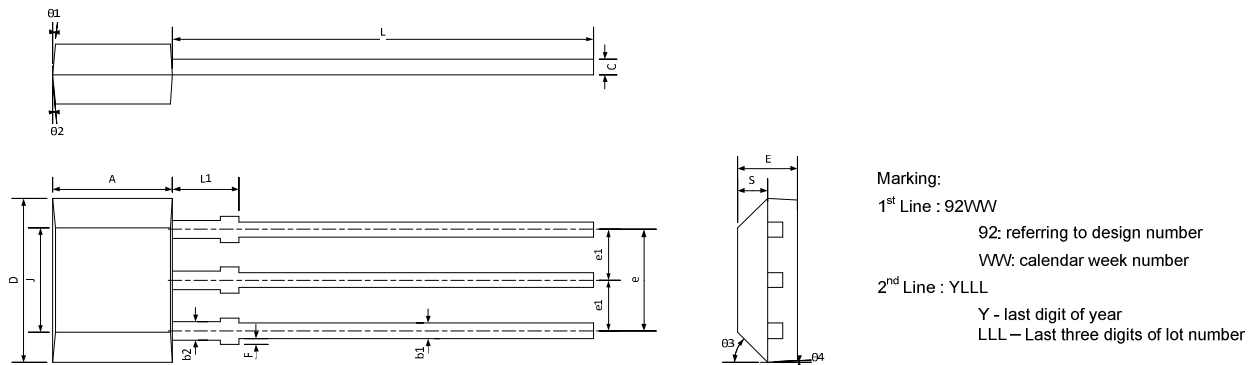
**Notes:**

1. For proper operation the bypass capacitor C1 should be placed as close as possible to the VDD and GND pins.
2. If negative transients over supply line  $V_{PEAK} < -30V$  are expected, usage of the diode D1 is recommended. Otherwise only R1 is sufficient. When selecting the resistor R1, three points are important:
  - the resistor has to limit  $I_{DD}/I_{DDREV}$  to 40mA maximum
  - the resistor has to withstand the power dissipated in both over voltage conditions ( $V_{R1}^2/R1$ )
  - the resulting device supply voltage  $V_{DD}$  has to be higher than  $V_{DD\ min}$  ( $V_{DD} = V_{CC} - R1 \cdot I_{DD}$ )
3. If positive transients over supply line with  $V_{PEAK} > 40V$  are expected, usage of Zener diode Z1 is recommended. The R1-Z1 network should be sized to limit the voltage over the device below the maximum allowed.



## 12 Package Information

### 12.1 UA (TO92-3L) Package Information

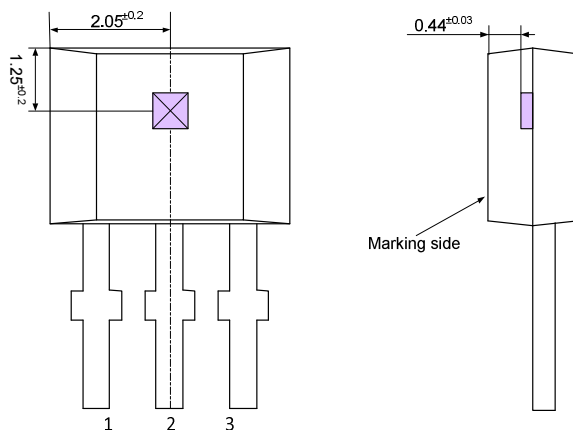


	A	D	E	F	J	L	L1	S	b1	b2	c	e	e1
min	2.80	3.90	1.40	0.00	2.51	14.0	0.90	0.63	0.35	0.43	0.35	2.51	1.24
max	3.20	4.30	1.60	0.20	2.72	15.0	1.10	0.84	0.44	0.52	0.44	2.57	1.30
	θ1	θ2	θ3	θ4									
min	7° REF	7° REF	45° REF	7° REF									
max													

Notes:

1. All dimensions are in millimetres.
2. Mold flashes and protrusion are not included.
3. Gate burrs shall not exceed 0.127mm on the top side.

#### Hall plate location

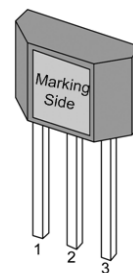


Notes:

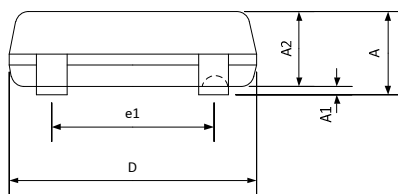
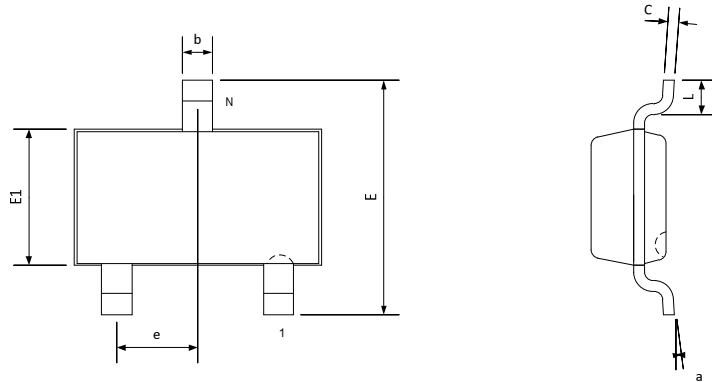
1. All dimensions are in millimeters
2. Mold flashes and protrusion are not included.

UA Pin №	Name	Type	Function
1	VDD	Supply	Supply Voltage pin
2	GND	Ground	Ground pin
3	OUT	I/O	Output&Test I/O

Table 1: UA Package pinout



## 12.2 SE (TSOT-3L) Package Information

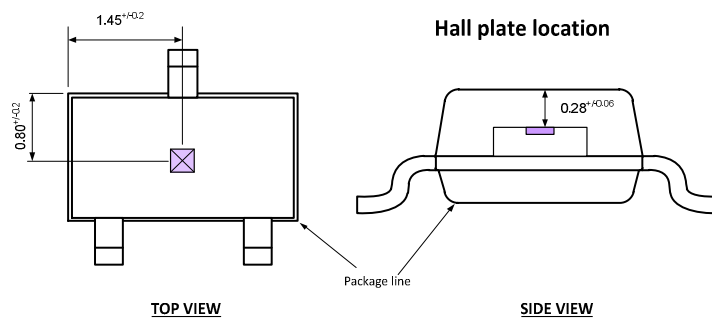


Marking:  
TOP:  
 92WW – Normal sensitivity version  
 93WW – Lateral sensitivity version  
 WW: Assembly week  
BOTTOM:  
 YLLL  
 Y: Assembly Year  
 LLL: Last 3 digits from lot#

	A	A1	A2	D	E	E1	L	b	c	e	e1	$\alpha$
min	–	0.025	0.85	2.80	2.60	1.50	0.30	0.30	0.10	0.95	1.90	0°
max	1.00	0.10	0.90	3.00	3.00	1.70	0.50	0.45	0.20	BSC	BSC	8°

**Notes:**

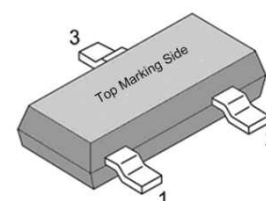
1. Dimension “D” and “E1” do not include mold flash or protrusions. Mold flash or protrusion shall not exceed 0.15mm on “D” and 0.25mm on “E” per side.
2. Dimension “b” does not include dambar protrusion.



Notes:  
 1. All dimensions are in millimeters  
 2. XY Hall plate position tolerances do not include the mold flashes and protrusions described in the package drawing

SE Pin №	Name	Type	Function
1	VDD	Supply	Supply Voltage pin
2	OUT	I/O	Output&Test I/O
3	GND	Ground	Ground pin

Table 2: SE Package pinout



## 13 Standard information regarding manufacturability of Melexis products with different soldering processes

Our products are classified and qualified regarding soldering technology, solderability and moisture sensitivity level according to following test methods:

### Reflow Soldering SMD's (Surface Mount Develops)

- IPC/JEDEC J-STD-020  
Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices  
(classification reflow profiles according to table 5-2)
- EIA/JEDEC JESD22-A113  
Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing  
(reflow profiles according to table 2)

### Wave Soldering SMD's (Surface Mount Develops) and THD's (Through Hole Develops)

- EN60749-20  
Resistance of plastic- encapsulated SMD's to combined effect of moisture and soldering heat
- EIA/JEDEC JESD22-B106 and EN60749-15  
Resistance to soldering temperature for through-hole mounted devices

### Iron Soldering THD's (Through Hole Develops)

- EN60749-15  
Resistance to soldering temperature for through-hole mounted devices

### Solderability SMD's (Surface Mount Develops) and THD's (Through Hole Develops)

- EIA/JEDEC JESD22-B102 and EN60749-21  
Solderability

For all soldering technologies deviating from above mentioned standard conditions (regarding peak temperature, temperature gradient, temperature profile etc) additional classification and qualification tests have to be agreed upon with Melexis.

The application of Wave Soldering for SMD's is allowed only after consulting Melexis regarding assurance of adhesive strength between device and board.

Melexis is contributing to global environmental conservation by promoting **lead free** solutions. For more information on qualifications of **RoHS** compliant products (RoHS = European directive on the Restriction Of the use of certain Hazardous Substances) please visit the quality page on our website: <http://www.melexis.com/quality.aspx>

## 14 ESD Precautions

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD).  
Always observe Electro Static Discharge control procedures whenever handling semiconductor products.

## 15 Contact

For the latest version of this document, go to our website at [www.melexis.com](http://www.melexis.com).

For additional information, please contact our Direct Sales team and get help for your specific needs:

Europe, Africa	Telephone: +32 13 67 04 95
	Email : <a href="mailto:sales_europe@melexis.com">sales_europe@melexis.com</a>
Americas	Telephone: +1 603 223 2362
	Email : <a href="mailto:sales_usa@melexis.com">sales_usa@melexis.com</a>
Asia	Email : <a href="mailto:sales_asia@melexis.com">sales_asia@melexis.com</a>

## 16 Disclaimer

The information furnished by Melexis herein ("Information") is believed to be correct and accurate. Melexis disclaims (i) any and all liability in connection with or arising out of the furnishing, performance or use of the technical data or use of the product(s) as described herein ("Product") (ii) any and all liability, including without limitation, special, consequential or incidental damages, and (iii) any and all warranties, express, statutory, implied, or by description, including warranties of fitness for particular purpose, non-infringement and merchantability. No obligation or liability shall arise or flow out of Melexis' rendering of technical or other services.

The Information is provided "as is" and Melexis reserves the right to change the Information at any time and without notice. Therefore, before placing orders and/or prior to designing the Product into a system, users or any third party should obtain the latest version of the relevant information to verify that the information being relied upon is current.

Users or any third party must further determine the suitability of the Product for its application, including the level of reliability required and determine whether it is fit for a particular purpose.

The Information is proprietary and/or confidential information of Melexis and the use thereof or anything described by the Information does not grant, explicitly or implicitly, to any party any patent rights, licenses, or any other intellectual property rights.

This document as well as the Product(s) may be subject to export control regulations. Please be aware that export might require a prior authorization from competent authorities.

The Product(s) are intended for use in normal commercial applications. Unless otherwise agreed upon in writing, the Product(s) are not designed, authorized or warranted to be suitable in applications requiring extended temperature range and/or unusual environmental requirements. High reliability applications, such as medical life-support or life-sustaining equipment are specifically not recommended by Melexis.

The Product(s) may not be used for the following applications subject to export control regulations: the development, production, processing, operation, maintenance, storage, recognition or proliferation of 1) chemical, biological or nuclear weapons, or for the development, production, maintenance or storage of missiles for such weapons; 2) civil firearms, including spare parts or ammunition for such arms; 3) defense related products, or other material for military use or for law enforcement; 4) any applications that, alone or in combination with other goods, substances or organisms could cause serious harm to persons or goods and that can be used as a means of violence in an armed conflict or any similar violent situation.

The Products sold by Melexis are subject to the terms and conditions as specified in the Terms of Sale, which can be found at <https://www.melexis.com/en/legal/terms-and-conditions>.

This document supersedes and replaces all prior information regarding the Product(s) and/or previous versions of this document.

Melexis NV © - No part of this document may be reproduced without the prior written consent of Melexis. (2016)

ISO/TS 16949 and ISO14001 Certified